

SILICON TRANSISTOR 2SA1400-Z

PNP SILICON TRIPLE DIFFUSED TRANSISTOR MP-3

DESCRIPTION

2SA1400-Z is designed for High Voltage Switching, especially in Hybrid Integrated Circuits.

FEATURES

• High Voltage : VcEo = −400 V

• High Speed : $t_f \le 1.0 \mu s$

• Complement to 2SC3588-Z

QUALITY GRADE

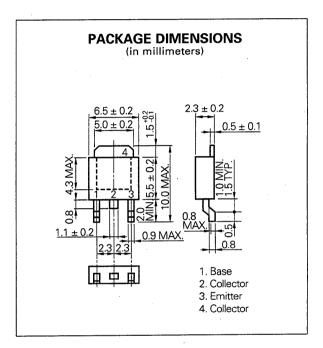
Standard

Please refer to "Quality grade on NEC Semiconductor Devices" (Document number IEI-1209) published by NEC Corporation to know the specification of quality grade on the devices and its recommended applications.

ABSOLUTE MAXIMUM RATINGS (Ta = 25 °C)

Collector to Base Voltage	Vсво	-400	٧
Collector to Emitter Voltage	VCEO	-400	٧
Emitter to Base Voltage	Vево	- 7	٧
Collector Current (DC)	Ic	-0.5	Α
Collector Current (Pulse)*	lc	-1.0	Α
Total Power Dissipation ($T_a = 25 ^{\circ}C$)**	PT	2.0	W
Junction Temperature	T_j	150	°C
Storage Temperature	T _{stg} -55	to +150	°C

- * PW \leq 300 μ s, Duty Cycle \leq 10 %
- ** When mounted on ceramic substrate of 7.5 cm $^2 \times 0.7$ mm



ELECTRICAL CHARACTERISTICS (Ta = 25 °C)

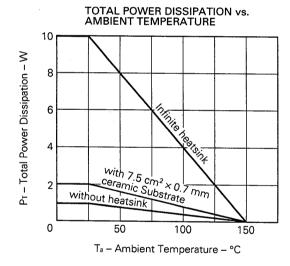
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Collector Cutoff Current	Ісво			-100	μΑ	VcB = -400 V, IE = 0
Emitter Cutoff Current	Ієво	-		-10	μА	VEB = -5.0 V, Ic = 0
DC Current Gain	h _{FE} *	30		200		VcE = -5.0 V, Ic = -50 mA
Collector Saturation Voltage	V _{CE(sat)} *			-1.0	V	Ic = -100 mA, Is = -10 mA
Base Saturation Voltage	VBE(sat)*			-1.2	V	Ic = -100 mA, Is = -10 mA
Turn-on Time	ton			1.0	μs	$lc = -100$ mA, $R_L = 1.5$ k Ω
Storage Time	tstg			5.0	μѕ	$l_{B1} = -1_{B2} = -10 \text{ mA},$
Fall time	tr			1.0	μs	- Vcc = -150 V PW ≦ 50 μs, Duty Cycle ≦ 2 %

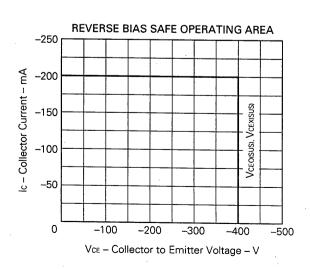
^{*} Pulsed: PW \leq 350 μ s, Duty Cycle \leq 2 %

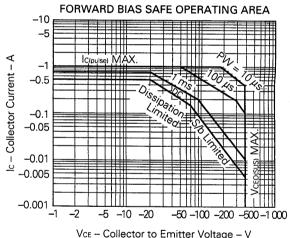
hFE Classification

MARKING	N	М	L	К
hre ·	30 to 60	40 to 80	60 to 120	100 to 200

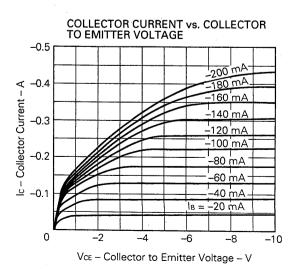
TYPICAL CHARACTERISTICS (Ta = 25 °C)



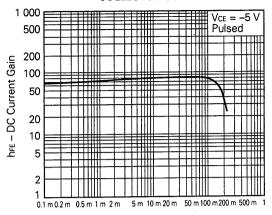




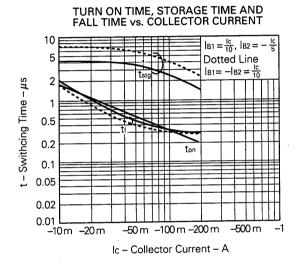
Vce - Collector to Emitter Voltage - V



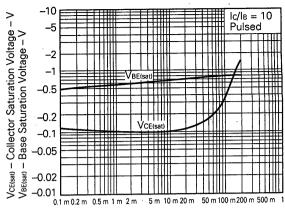
DC CURRENT GAIN vs. COLLECTOR CURRENT



Ic - Collector Current - A



BASE COLLECTOR SATURATION VOLTAGE vs. COLLECTOR CURRENT



Ic - Collector Current - A

Reference

Application note name	No.
Quality control of NEC semiconductors devices.	TEI-1202
Quality control guide of semiconductors devices.	MEI-1202
Assembly manual of semiconductors devices.	IEI-1207
Design of Push-Pull Type Switching Regulators (Basic).	TEB-1002
Design of Push-Pull Type Switching Regulators (Applications).	TEB-1003
Optimum Base Drive Conditions of Switching Power Transistors.	TEB-1014

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Application examples recommended by NEC Corporation.

Standard: Computer, Office equipment, Communication equipment, Test and Measurement equipment, Machine tools, Industrial robots, Audio and Visual equipment, Other consumer products, etc.

Special: Automotive and Transportation equipment, Traffic control systems, Antidisaster systems, Anticrime systems, etc.

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